

Thyristor Modules

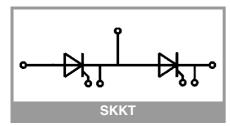
SKKT 107/16 E

Features

- Heat transfer through aluminium oxide ceramic isolated metal baseplate
- UL recognized, file no. E63532

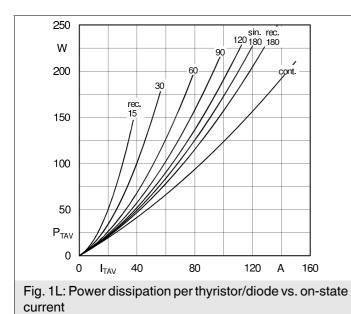
Typical Applications*

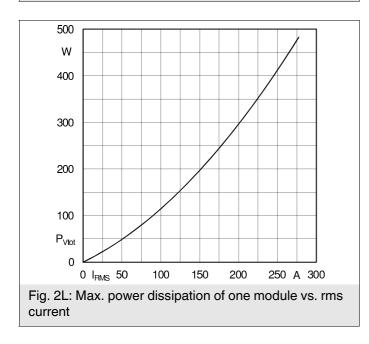
- DC motor control (e. g. for machine tools)
- AC motor soft starters
- Temperature control (e. g. for ovens, chemical processes)
- Professional light dimming (studios, theaters)

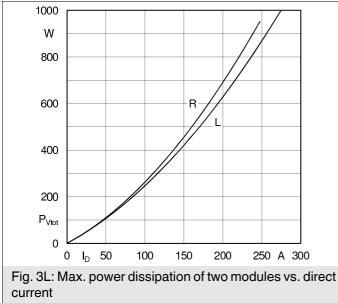


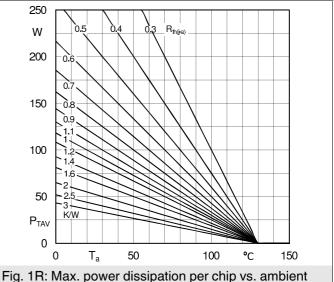
Absolute	Maximum Rating	S			
Symbol	Conditions		Values	Unit	
Chip					
I _{T(AV)}	sinus 180°	T _c = 85 °C	119	А	
		T _c = 100 °C	91	А	
I _{TRMS}	continuous operation		190	А	
I _{TSM}	- 10 ms	T _j = 25 °C	2250	А	
		T _j = 130 °C	1900	A	
i ² t	_ 10 ms	T _j = 25 °C	25313	A²s	
		T _j = 130 °C	18050	A ² s	
V _{RSM}			1700	V	
V _{RRM}			1600	V	
V _{DRM}			1600	V	
(di/dt) _{cr}	T _j = 130 °C		140	A/μs	
(dv/dt) _{cr}	T _j = 130 °C		1000 V		
Tj			-40 130	°C	
Module				·	
T _{stg}			-40 125	°C	
V _{isol}	a.c.; 50 Hz; r.m.s.	1 min 3000		V	
		1 s	3600	V	

Characte	eristics					
Symbol	Conditions	min.	typ.	max.	Unit	
Chip						
V _T	$T_j = 25 \ ^{\circ}C, I_T = 300 \ A$			1.6	1.75	V
V _{T(TO)}	T _j = 130 °C			0.8	0.9	V
r _T	T _j = 130 °C			2.80	3.35	mΩ
I _{DD} ;I _{RD}	$T_j = 130 \ ^\circ C$, $V_{DD} = V_{DRM}$; $V_{RD} = V_{RRM}$				20	mA
t _{gd}	$T_j = 25 \ ^\circ C$, $I_G = 1 \ A$, $di_G/dt = 1 \ A/\mu s$			1		μs
t _{gr}	$V_{D} = 0.67 * V_{DRM}$			2		μs
t _q	T _j = 130 °C			200		μs
I _H	T _j = 25 °C			150	250	mA
ΙL	$T_j = 25 \ ^\circ C$, $R_G = 33 \ \Omega$			300	600	mA
V_{GT}	$T_{j} = 25 \ ^{\circ}C, \ d.c.$		2.5			V
I _{GT}	$T_{j} = 25 \ ^{\circ}C, \ d.c.$		100			mA
V_{GD}	T _j = 130 °C, d.c.				0.25	V
I _{GD}	T _j = 130 °C, d.c.				4	mA
R _{th(j-c)}	continuous DC	per chip			0.19	K/W
		per module			0.095	K/W
R _{th(j-c)}	sin. 180°	per chip			0.2	K/W
		per module			0.1	K/W
R _{th(j-c)}	rec. 120°	per chip			0.21	K/W
		per module			0.105	K/W
Module						
R _{th(c-s)}	chip			0.22		K/W
	module			0.11		K/W
Ms	to heatsink M5		4.25		5.75	Nm
Mt	to terminals M5		2.55		3.45	Nm
а					5 * 9,81	m/s²
w				75		g

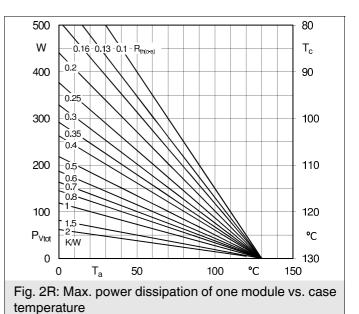












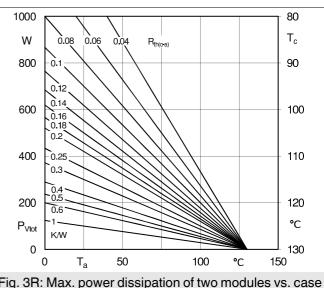
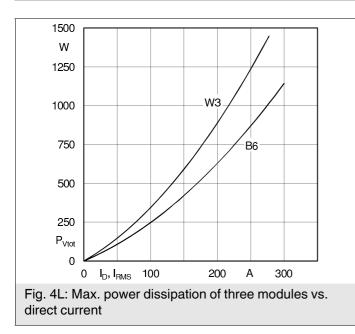
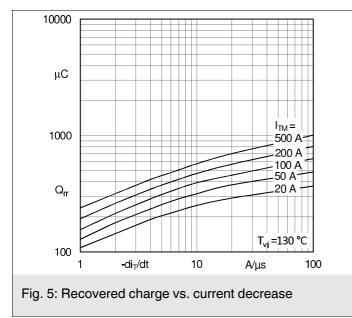
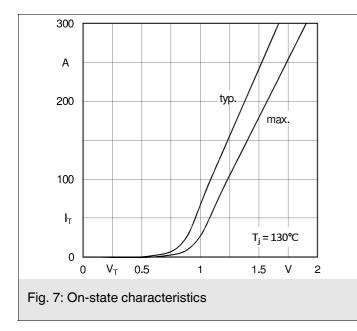
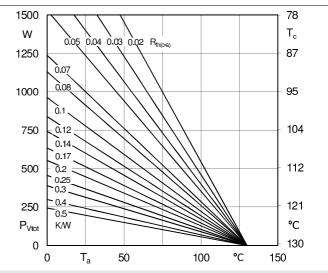


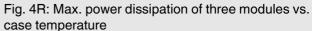
Fig. 3R: Max. power dissipation of two modules vs. case temperature

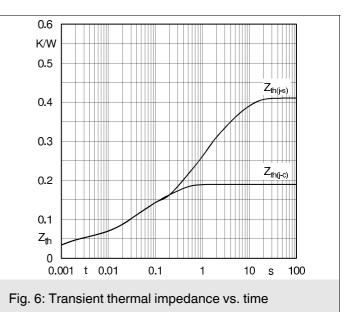


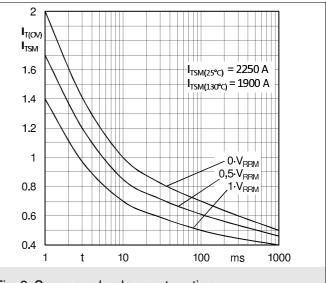


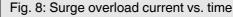


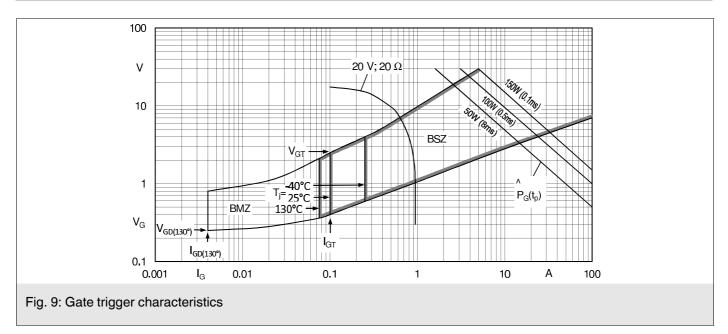


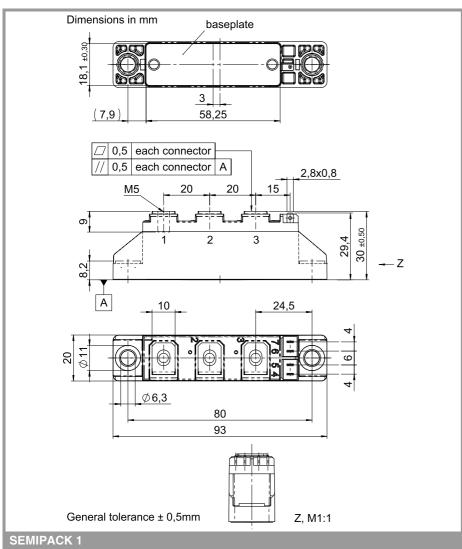


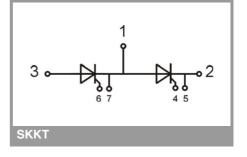












This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, chapter IX.

*IMPORTANT INFORMATION AND WARNINGS

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